

MSP10C01180RGEJ

MSP10C01180RGEJ Information

Part Number MSP10C01180RGEJ

Manufacturer Vishay Dale Category Resistors

Resistor Networks, Arrays

Description RES ARRAY 9 RES 180 OHM 10SIP

Package 10-SIP

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



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MSP10C01180RGEJ Specifications

Manufacturer MSP10C01180RGEJ Manufacturer Vishay Dale Category Resistors Resistor Networks, Arrays Package 10-SIP Series MSP Circuit Type Bussed Resistance (Ohms) 180 Tolerance ±2% Number of Resistors 9 Number of Pins 10 Power Per Element 250mW Temperature Coefficient ±100ppm/°C Operating Temperature -55°C ~ 125°C Applications - Mounting Type Through Hole Package / Case 10-SIP Supplier Device Package 10-SIP Size / Dimension 0.990" L x 0.090" W (25.15mm x 2.29mm) Height - Seated (Max) 0.350" (8.89mm)		
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Tolerance ±2% Number of Resistors 9 Number of Pins 10 Power Per Element 250mW Temperature Coefficient ±100ppm/°C Operating Temperature -55°C ~ 125°C Applications - Mounting Type Through Hole Package / Case 10-SIP Supplier Device Package 10-SIP Size / Dimension 0.990" L x 0.090" W (25.15mm x 2.29mm) Height - Seated (Max) 0.350" (8.89mm)	Circuit Type	Bussed
Number of Resistors9Number of Pins10Power Per Element250mWTemperature Coefficient±100ppm/°COperating Temperature-55°C ~ 125°CApplications-Mounting TypeThrough HolePackage / Case10-SIPSupplier Device Package10-SIPSize / Dimension0.990" L x 0.090" W (25.15mm x 2.29mm)Height - Seated (Max)0.350" (8.89mm)	Resistance (Ohms)	180
Number of Pins Power Per Element 250mW Temperature Coefficient ±100ppm/°C Operating Temperature -55°C ~ 125°C Applications - Mounting Type Through Hole Package / Case 10-SIP Supplier Device Package Size / Dimension 0.990" L x 0.090" W (25.15mm x 2.29mm) Height - Seated (Max) 0.350" (8.89mm)	Tolerance	±2%
Power Per Element 250mW Temperature Coefficient ±100ppm/°C Operating Temperature -55°C ~ 125°C Applications - Mounting Type Through Hole Package / Case 10-SIP Supplier Device Package 10-SIP Size / Dimension 0.990" L x 0.090" W (25.15mm x 2.29mm) Height - Seated (Max) 0.350" (8.89mm)	Number of Resistors	9
Temperature Coefficient ±100ppm/°C Operating Temperature -55°C ~ 125°C Applications - Mounting Type Through Hole Package / Case 10-SIP Supplier Device Package 10-SIP Size / Dimension 0.990" L x 0.090" W (25.15mm x 2.29mm) Height - Seated (Max) 0.350" (8.89mm)	Number of Pins	10
Operating Temperature -55°C ~ 125°C Applications - Mounting Type Through Hole Package / Case 10-SIP Supplier Device Package 10-SIP Size / Dimension 0.990" L x 0.090" W (25.15mm x 2.29mm) Height - Seated (Max) 0.350" (8.89mm)	Power Per Element	250mW
Applications - Mounting Type Through Hole Package / Case 10-SIP Supplier Device Package 10-SIP Size / Dimension 0.990" L x 0.090" W (25.15mm x 2.29mm) Height - Seated (Max) 0.350" (8.89mm)	Temperature Coefficient	±100ppm/°C
Mounting Type Through Hole Package / Case 10-SIP Supplier Device Package 10-SIP Size / Dimension 0.990" L x 0.090" W (25.15mm x 2.29mm) Height - Seated (Max) 0.350" (8.89mm)	Operating Temperature	-55°C ~ 125°C
Package / Case 10-SIP Supplier Device Package 10-SIP Size / Dimension 0.990" L x 0.090" W (25.15mm x 2.29mm) Height - Seated (Max) 0.350" (8.89mm)	Applications	-
Supplier Device Package 10-SIP Size / Dimension 0.990" L x 0.090" W (25.15mm x 2.29mm) Height - Seated (Max) 0.350" (8.89mm)	Mounting Type	Through Hole
Size / Dimension 0.990" L x 0.090" W (25.15mm x 2.29mm) Height - Seated (Max) 0.350" (8.89mm)	Package / Case	10-SIP
Height - Seated (Max) 0.350" (8.89mm)	Supplier Device Package	10-SIP
	Size / Dimension	0.990" L x 0.090" W (25.15mm x 2.29mm)
	Height - Seated (Max)	0.350" (8.89mm)
Report errors?		Report errors?

MSP10C01180RGEJ Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

MSP10C01180RGEJ Payment Methods



















MSP10C01180RGEJ Shipping Methods













If you have any question about MSP10C01180RGEJ, please do not hesitate to contact us!

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